

FEE TRANSMITTAL

Electronic Version v08

Stylesheet Version v08.0

**Title of
Invention**

ALL-IN-ONE POLISHING PROCESS FOR A SEMICONDUCTOR WAFER

Application Number :

Date :

First Named Applicant: Mu-Liang Liao

Attorney Docket Number: NAUP0511USA

TOTAL FEE AUTHORIZED \$ 882

Patent fees are subject to annual revisions on or about October 1st of each year.

Filing as large entity

BASIC FILING FEE

| Fee Description | Fee Code | Amount \$ | Fee Paid \$ |
|--|----------|-----------|-------------|
| Utility Filing Fee | 1001 | 770 | 770 |
| Subtotal For Basic Filing Fees: \$ 770 | | | |

EXTRA CLAIM FEES

| Fee Description | Extra Claim | Fee Code | Amount \$ | Fee Paid \$ |
|---------------------------------------|-------------|----------|-----------|-------------|
| Total Claims : 24 | 4 | 1202 | 18 | 72 |
| Independent Claims : 3 | 0 | 1201 | 86 | 0 |
| Subtotal For Extra Claims Fees: \$ 72 | | | | |

ASSIGNMENT FEES

| Fee Description | Property Number | Quantity | Fee Code | Amount \$ | Fee Paid \$ |
|---|-----------------|----------|----------|-----------|-------------|
| Recording Each Patent Assignment Per Property Fee | 00000000 | 1 | 8021 | 40 | 40 |
| Subtotal For Additional Fees: \$40 | | | | | |

AUTHORIZED BILLING INFORMATION**The commissioner is hereby authorized to charge indicated fees and credit any overpayments to:**

Deposit account number: 500801

Access Code ****

Deposit name: NORTH AMERICA INTERNATIONAL PATENT OFFICE

Deposit authorized name: WINSTON HSU

Signature: VAEB-JMXX-8IIL

Date (YYYYMMDD): 2004-01-15

Charge Assignment Fees Required Under 37 C.F.R. Section 1.21 (h).

Charge Any Additional Fee Required Under 37 C.F.R. Sections 1.16 and 1.17.